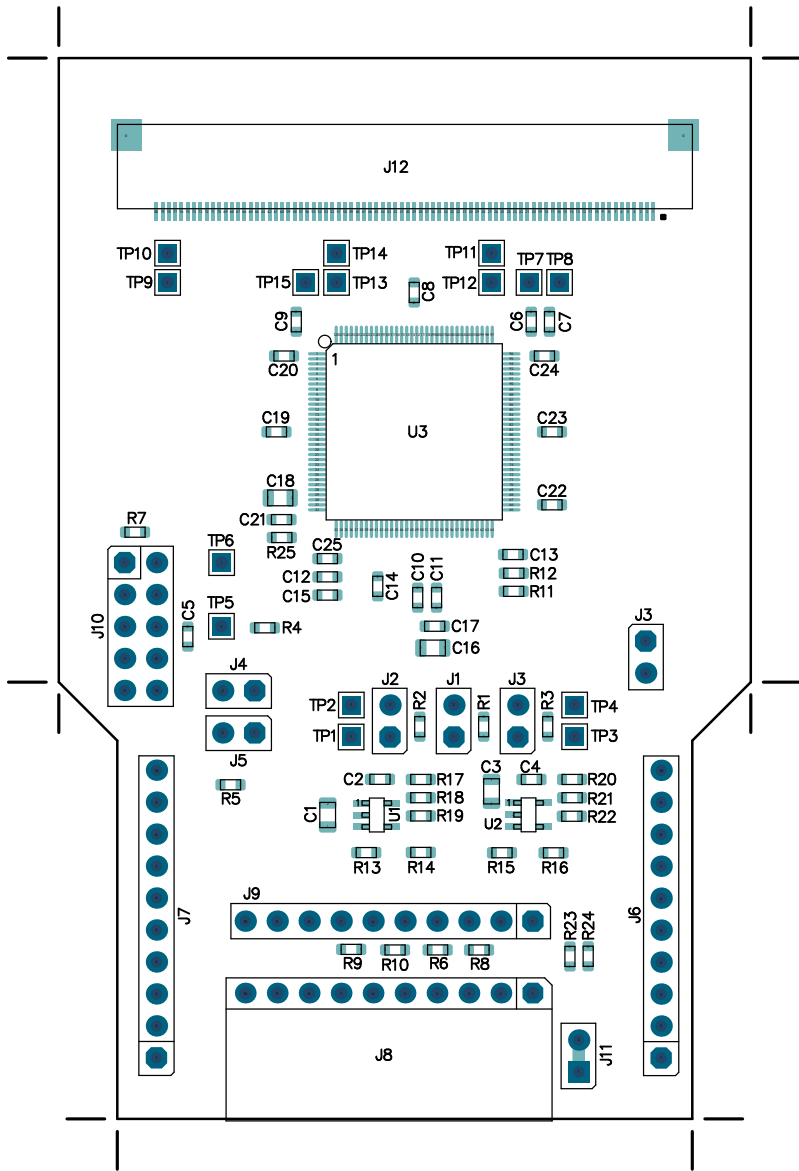


REV	ECO	Comments	Date
A0	N/A	First Issue	20th Feb 2017
1	N/A	RoHS, WEEE & CE symbols added	6th June 2018
2	N/A	Power test headers reworked to suit Keysight tester. Board number changed per Dev Tools ATM	12th July 2019

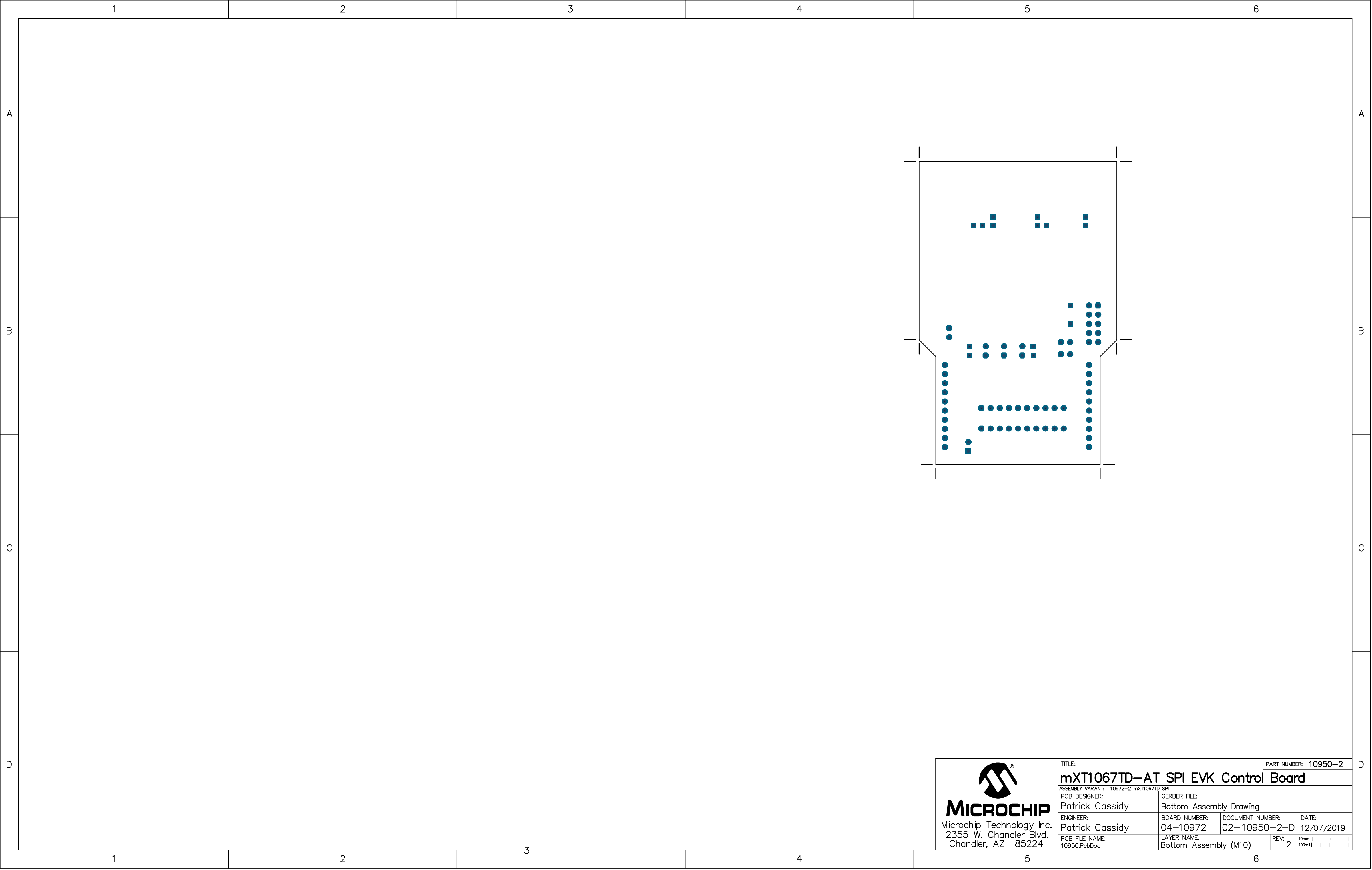


ASSEMBLY NOTES:

1. ALL COMPONENTS SHALL BE RoHS COMPLIANT.
2. ALL UNUSED THROUGH HOLE COMPONENT LOCATIONS SHALL BE FREE OF SOLDER.
3. ALL TEST POINT THROUGH HOLES (DENOTED TPxx) SHALL BE FREE OF SOLDER.
4. ALL COMPONENTS SHALL BE MOUNTED FLUSH TO THE BOARD, EXCEPT AS NOTED.
5. FINISHED BOARD SHALL BE FREE OF ALL RESIDUES.
6. ALL LEADS SHALL BE TRIMMED TO A MAXIMUM HEIGHT OF 2mm.
7. PLACE LABELS ON THE LOCATION INDICATED.



TITLE:		PART NUMBER: 10950-2	
mXT1067TD-AT SPI EVK Control Board			
ASSEMBLY VARIANT: 10972-2 mXT1067TD SPI			
PCB DESIGNER:		GERBER FILE:	
Patrick Cassidy		Top Assembly Drawing	
ENGINEER:		BOARD NUMBER:	DOCUMENT NUMBER:
Patrick Cassidy		04-10972	02-10950-2-D
PCB FILE NAME:		LAYER NAME:	REV:
10950.PcbDoc		Top Assembly (M11)	2



TITLE:		PART NUMBER: 10950-2	
mXT1067TD-AT SPI EVK Control Board			
ASSEMBLY VARIANT: 10972-2 mXT1067TD SPI			
PCB DESIGNER:		GERBER FILE:	
Patrick Cassidy		Bottom Assembly Drawing	
ENGINEER:		BOARD NUMBER:	DOCUMENT NUMBER:
Patrick Cassidy		04-10972	02-10950-2-D
PCB FILE NAME:		LAYER NAME:	REV:
10950.PcbDoc		Bottom Assembly (M10)	2

